



SPECIFICATION

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N: CL10B105KA8NFNC

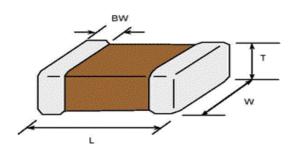
· Product : Multi-layer Ceramic Capacitor · Description : CAP, 1uF, 25V, ±10%, X7R, 0603

A. Samsung Part Number

<u>CL</u> <u>10</u> <u>B</u> <u>105</u> <u>K</u> <u>A</u> <u>8</u> <u>N</u> <u>F</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ 8 ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor						
2	Size	0603 (inch code)	L: $1.60 \pm 0.10 \text{ mm}$		W:	$0.80 \pm 0.10 \text{ mm}$		
3	Dielectric	X7R	8	Inner electrode		Ni		
4	Capacitance	1 uF		Termination		Cu		
(5)	Capacitance	±10 %		Plating		Sn 100% (Pb Free)		
	tolerance		9	Product		Product for POWER application		
6	Rated Voltage	25 V	10	Special		Reserved for future use		
7	Thickness	$0.80 \pm 0.10 \text{ mm}$	11)	Packaging		Cardboard Type, 7" reel		

B. Structure & Dimension



Samoung D/N	Dimension(mm)					
Samsung P/N	L	W	Т	BW		
CL10B105KA8NFNC	1.60 ± 0.10	0.80 ± 0.10	0.80 ± 0.10	0.30 ± 0.20		

C. Samsung Reliablility Test and Judgement Condition

Tan δ (DF)0.1 max.treated at 150 ℃ +0/-10 ℃ for 1 ho ambient air for 24±2 hours.Insulation10,000Mohm or 100Mohm×μFRated Voltage60~120 sec.ResistanceWhichever is smallerMicroscope (×10)					
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Resistance Whichever is smaller Appearance No abnormal exterior appearance Microscope (×10)	*A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C for 1 hour and maintained in ambient air for 24±2 hours.				
Appearance No abnormal exterior appearance Microscope (×10)					
With standing No dislocation broaded was a 250% of the rested vallence					
Withstanding No dielectric breakdown or 250% of the rated voltage	250% of the rated voltage				
Voltage mechanical breakdown					
Temperature X7R					
Characteristics (From-55 ℃ to 125 ℃, Capacitance change should be within ±15%)					
Adhesive Strength No peeling shall be occur on the 500g·f, for 10±1 sec.	T .				
of Termination terminal electrode					
Bending Strength Capacitance change: within ±12.5% Bending to the limit (1mm)					
with 1.0mm/sec.					
Solderability More than 75% of terminal surface SnAg3.0Cu0.5 solder					
is to be soldered newly 245±5°C, 3±0.3sec.					
(preheating : 80~120°C for 10~30	sec.)				
Resistance to Capacitance change: within ±7.5% Solder pot : 270±5°C, 10±1sec.					
Soldering Heat Tan δ, IR : initial spec.					
Vibration TestCapacitance change : within \pm 5%Amplitude : 1.5mmTan δ, IR : initial spec.From 10Hz to 55Hz (return : 1min. 2hours \times 3 direction (x, y, z))				
Moisture Capacitance change: within ±12.5% With rated voltage					
Resistance Tan δ : 0.125 max 40±2°C, 90~95%RH, 500+12/-0hr	rs				
IR: 500Mohm or 12.5Mohm × μF Whichever is smaller					
High Temperature Capacitance change: within ±12.5% With 150% of the rated voltage	ge				
Resistance Tan δ : 0.125 max Max. operating temperature					
IR: 1,000Mohm or 25Mohm × μ F 1000+48/-0hrs Whichever is smaller					
Temperature Capacitance change: within ±7.5% 1 cycle condition					
Cycling Tan δ, IR : initial spec. Min. operating temperature	→ 25°C				
→ Max. operating temperature	e → 25°C				
5 cycle test					

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.